MOCVD of Molybdenum Sulphide Thin Film via Single Solid Source Precursor Bis-(Morpholinodithioato-s,s’)-Mo

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Abstract

A single solid source precursor bis-(morpholinodithioato-s,s’)-Mo was prepared and molybdenum sulphide thin film was deposited on sodalime glass using Metal Organic Chemical Vapour Deposition (MOCVD) technique at deposition temperature of 420°C. The film was characterized using Rutherford Backscattering Spectroscopy (RBS), Ultraviolet-Visible Spectroscopy, Four-point Probe technique, Scanning Electron Microscopy (SEM), X-ray Diffractometry (XRD) and Atomic Force Microscopy (AFM). A direct optical band gap of 1.77 eV was obtained from the analysis of the absorption spectrum. The sheet resistance was found to be of the order of $10^{-5} \Omega^{-1} \cdot \text{cm}^{-1}$. SEM micrographs of the films showed the layered structure of the film with an estimated grain size that is less than 2 µm while XRD indicates parallel orientation of the basal plane to the substrate surface.

Keywords: Molybdenum Sulphide, Precursor, Metal Organic Chemical Vapour Deposition (MOCVD), Thin Film, Characterization

1. Introduction

Transition metal chalcogenides constitute an important class of functional materials that are prime candidates for the exploration of structure-property relationships in solids. Subtle changes in shape, size and phase of these materials result in variations in physical properties which can be exploited for various technological applications. This wide range of interesting technological applications has been the primary driving force behind much of the interest in these solid state compounds. Transition metal dichalcogenides (TMDC) have been widely studied [1-3]. These materials exhibit a wide range of electronic properties ranging from insulating to conducting with evidence of superconductivity in some of the members of the class [4].

The unique characteristic of molybdenum disulphide, MoS₂ is its highly anisotropic crystal layer structure. It is characterized by a lamellar structure which is similar to that of graphite [2]. Monolayers of Mo are sandwiched between monolayers of sulphur which are held together by relatively weak Van der Waals bonding between S-Mo-S layers. There is a strong covalent bonding within the sandwiches i.e. between molybdenum and sulphur atom. Each layer comprises of a layer of Mo atoms arranged in hexagonal array situated between two hexagonal layers of S atoms. Furthermore, the MoS₂ layer structure can exhibit two types of crystalline orientation, either the basal planes are parallel or perpendicular to the substrate. In contrast, MoS₃ exist only in an amorphous form with short range order [5].

Molybdenum sulphide thin films have also found industrial applications in the field of optical devices and electronics. These applications arise from their optical and electrical properties. They have band gaps (1.1 - 1.8 eV) well fitted to solar spectrum [6-8]. The direct and indirect gaps are derived from non bonding molecular orbital which leads to high corrosion resistance [9]. As a result, they are excellent candidates for efficient solar energy cells [10,11]. The layered structure of molybdenum sulphide enables weak Van der Waals interaction at the surface interface substantially relieving the lattice mismatch problem which leads to generation of dislocation at the interface that acts as minority carrier recombination centers detrimental to cell efficiency. Photovoltaic applications of these materials have been suggested and encouraging results were obtained. However, Jamieson and Jakovidis (2004) [12] proposed that
MoS$_2$ thin films must be textured for an efficient hetero-junction photovoltaic cell. Ponomarev et al. (1998) [13] on the other hand concluded that MoS$_2$ thin films are photoactive in which photoconductivity measurements reveal a direct band gap of 1.71 eV with Van der Waals planes parallel to substrate.

Molybdenum sulphide thin films also have wide range of potential application as field emitters [14,15], thermoelectric materials [16], catalyst [17], in electrochromic devices [18,19], and as cathode in secondary lithium batteries [20-22]. The intercalation of lithium into molybdenum sulphide produces a material that is highly useful in lithium ion batteries because of its ability to exchange lithium reversibly in non aqueous electrolytes. The amount of intercalated lithium and also the reversibly extracted lithium depend on the quality of MoS$_2$ and their prior treatment [23]. Furthermore, Imanishi et al. (1992) [20] observed that the discharge and charge characteristics strongly depend on the lithium diffusion in the Van der Waals gap.

Molybdenum sulphide thin films have been prepared by variety of techniques. Such techniques include spin coating [5,24], radio frequency (rf) sputtering [12,25,26], dc magnetron sputtering [27-31], dip coating [32], pulsed laser deposition and pulsed laser ablation [33-35]. Others include, electrodeposition [6,11,13], successive ionic layer adsorption and reaction (SILAR) [36], Chemical reaction technique [37], CVD [38-40] and so on. In the latter case, Schleich et al. (1989) [40] used molybdenum hexafluoride (MoF$_6$) and Hexamethyldisulphide (HMDST) as precursors while Endler et al. (1999) [38] used MoCl$_5$ and H$_2$S as precursors. However, Cheon et al. (1997) [39] used a metal organic precursor tert-butyl thioate Mo (S-t-Bu)$_4$ which is an air sensitive compound.

The use of MOCVD technique has received much attraction due to its great potential application to fabricate high quality films. Most of the other techniques have their different deficiencies ranging from non-uniformity of films to lack of reproducibility in composition of films with different levels of impurity. This is due to the fact that two or more precursor sources of different aerosol properties are used.

In this work, we report the preparation of bis-(morpholinodithioato-s,s')-Mo which is a single solid source precursor and the deposition of molybdenum sulphide thin films from this precursor through MOCVD method on sodalime glass substrate at deposition temperature of 420°C. Compositional study; optical and electrical characterization; surface morphology, structure and roughness of the films are also reported.

2. Experimental

2.1. Precursor Preparation

The single solid source precursor, bis-(morpholinodithioato-s,s')-Mo was prepared using the procedure reported by Ajayi et al. (1994) [41]. This method has also been extended to cover ternary and quaternary sulphides [42,43]. The intermediate complex, ammonium morpholino-dithiocarbamate was prepared according to the method reported by Ajayi et al. (1994) [41].

Ammonium morpholino-dithiocarbamate (14.42 g, 0.08 mol) was dissolved in warm methanol (60 cm$^3$) ensuring that the compound was completely dissolved. A solution of molybdenum(V) chloride, MoCl$_5$ (10.93 g, 0.04 mol) in methanol (60 cm$^3$), was then added dropwise to the solution of ammonium morpholino-dithiocarbamate in methanol while stirring vigorously on a hot plate. The product obtained as a precipitate was filtered off and later dried in a dessicator to yield 11.78 g (69.70% yield).

2.2. Thin Film Deposition

The thin film of molybdenum sulphide was prepared by the pyrolytic method of MOCVD which has been reported previously [44]. The substrate used was sodalime glass slides with composition O,Si,Na,Ca,Mg,Al = 60,25,10,3,1,1. The film was deposited at temperature of 420°C. The set up for the deposition is shown in Figure 1.
The fine powder of the precursor, bis-(morpholinodithioato-s,s’)-Mo was poured in an unheated receptacle and Argon gas (dried by passing it through calcium chloride) was blown through the fine powder precursor at the rate of 2.5 dm$^3$ per minute. The Argon borne precursor was transported into the working chamber which was maintained at 420°C by an electrically heated furnace. The substrates were supported on stainless steel blocks to ensure good and uniform thermal contact. The time of deposition was two hours. In the hot zone, the precursor first sublimed before thermal decomposition, resulting in the formation of the films. This method does not require a pump to remove the by-products as they are swept out by the carrier gas. It has the added advantage that heating of the source material is unnecessary. The whole process was carried out inside a fume hood.

2.3. Characterization of the Films

Rutherford backscattering spectroscopy (RBS) was used to determine the elemental composition, stoichiometry and thickness of the film. The RBS facility is a 7 MV Tandem accelerator of IBM geometry (scattering configuration where the incident beam, surface normal, and detected beam are all coplanar) with integrated beam dose of 10.0 µC. The detector solid angle was 0.833 msr with a resolution of 12 keV. The incident beam is He$^+$ with energy 2.2 MeV and beam current of 3.8 nA.

The optical absorbance of the thin film was investigated in order to study the optical behavior of the thin film using Pye-Unicam 400 series Helios Alpha Version 2.05 UV-Visible spectrophotometer. All measurements were made at room temperature with blank sodalime glass substrate in the reference beam. Standardization was done by first replacing the coated substrate with a plain substrate in the sample position; thus we had plain against plain substrate.

The electrical characterization of the film was performed using the four point probe technique. The four point collinear probe configuration was employed with silver paste at each of the points for ohmic contact. Current-voltage measurement was done using Keithley 2400 Source meter with Rolls and Keener probes. The two outer probes were used to source current while the two inner probes sense the resulting voltage drop across the sample. The distance of separation between each of the probe was 1 cm. A hand lens was used to monitor the probe from puncturing the film.

The surface morphology and surface roughness of the films were obtained using Zeiss Supra 40 with GEMINI column Scanning Electron Microscope and PSIA-XE 100 Atomic Force Microscopy machine. The electron beam of the SEM was 0.1 keV - 30 keV with nominal resolution of 1 nm at 10 keV. To achieve atomic scale resolution, a sharp stylus (radius~1 - 2 nm) attached to the cantilever was used in the AFM to scan point by point and contouring it while a constant small force is applied to the stylus. X-Ray Diffraction (XRD) of the film was performed with MD-10 model X-ray diffractometer using Cu-K$_\alpha$ radiation ($\lambda = 0.15418$ nm). Chemical phase identification was performed using a computer based system with the standard powder diffraction file (PDF) embedded in the diffractometer. A data base from the International Center for Diffraction Data was also used in comparing the XRD pattern of the films.

3. Results and Discussion

The compositional analysis of the film was carried out using Rutherford Backscattering Spectroscopy (RBS). RBS was also used to determine the thickness of the film. The RBS spectrum of the film is shown in Figure 2. The stoichiometric ratio of the film was found to be Mo:S = 0.33:0.67 while the thickness was estimated to be 70 nm. The mismatch in the RBS spectrum is as a result of charging effect from the substrate. This shows that the decomposition of bis-(morpholinodithioato-s,s’)-Mo in inert gas medium (Argon) produced molybdenum sulphide thin film.

Optical characterization constitutes the most direct and perhaps the simplest approach for probing the band structure of the deposited film. The UV-Visible spectrum of the thin film is shown in Figure 3. The spectrum is a plot of absorbance against incident photon wavelength at normal incidence and at room temperature. The UV-Visible spectrum shows that the optical absorbance of the film increases with increasing energy of the photon.
indicating that the film is highly absorbing in the visible region. Ponomarev et al. (1998) [13] attributed such strong absorption to the absorption of some impurities from the substrate or the presence of MoO$_x$. It could also be true in this case, since it is possible for some of the elements of the sodalime glass substrate to diffuse to the surface during the deposition process [45]. The strong absorption can also indicate high amount of defect. Light scattering from the micrometer sized grains of the film can also be the reason for the strong absorption in the visible region.

From both the absorbance and film thickness obtained from RBS, the absorption coefficient $\alpha$ was calculated from the expression

$$\alpha = \frac{1}{x} \ln \left( \frac{1}{T} \right)$$  \hspace{1cm} (1)$$

where, $x$ is the thickness of the film, $T = 10^{-a}$ is the transmittance and $a =$ absorbance. The dependence of absorption coefficient on photon energy can be obtained for optical transition processes using the time-dependent perturbation theory. The optical absorption at high values of absorption coefficient ($\alpha \geq 10^4$) above the exponential tail follows a power law of the general form

$$\alpha = A \left( h\nu - E_g \right)^n$$ (2)$$

where $h = \text{Planck’s constant}$, $\nu = \text{frequency}$, $E_g = \text{energy gap}$ and $A = \text{constant of proportionality}$. The exponent, $n$, which characterize the transition process can take values 2, 3, 1/2, or 3/2 for indirect allowed, indirect forbidden, direct allowed and direct forbidden transitions respectively. From equation 1 square of the absorption coefficient, $\alpha^2$ was calculated. Figure 4 shows the plot of $\alpha^2$ against the energy of the photon for the thin film. The extrapolation of the straight region of the graph to the energy axis gives the direct band gap energy for the thin film. The estimated value of the band gap is 1.77 eV.

This falls between the values of the band gaps reported for molybdenum sulphide thin films [6,10-13]. From the band structure of molybdenum sulphide, the energy gap is always between the filled dz$^2$ band and the higher lying conduction bands [46]. The dz$^2$ band may be half filled or completely filled. The transition then becomes easy which may correspond to the semiconducting behavior of the material. On the contrary, Schmidt et al. (1995) [47] reported a value of 1.05 eV which is a bit low. This was attributed to the presence of band tails characteristics of the amorphous state. In this case, a value of 1.77 eV may then suggest the crystalline state of the film.

Electrical characterization of the film was done using the four point probe method. The sheet resistance $R_s$ of the film was obtained using the expression [48],

$$R_s = \pi \ln 2 \left( \frac{V}{I} \right)$$

(3)

From the sheet resistance and the thickness from RBS, resistivity, $\rho$ and conductivity, $\sigma$ of the films were also calculated from the following equations,

$$\rho = R_s \times x = \frac{\pi x}{\ln 2} \left( \frac{V}{I} \right)$$

(4)

$$\sigma = \frac{1}{\rho}$$

(5)

The sheet resistance of film was estimated to be $2.25 \times 10^5 \, \Omega$/sq. The value obtained in this work is of the same order of magnitude with those reported in the literature. Ponomarev et al. (1998) [13] reported an approximate value of $7.1 \times 10^3 \, \Omega$/sq while Schleich et al. (1989) [40] reported a value of $0.9 \times 10^3 \, \Omega$/sq for MoS$_3$ thin films. From equations 3 and 4 with the value of the thickness obtained from RBS, the conductivity of the film was calculated to be $0.86 \, \Omega^{-1} \, \text{cm}^{-1}$. This is in agreement with values reported in the literature ($10^{-3} \, \Omega^{-1} \, \text{cm}^{-1}$ to $10^1 \, \Omega^{-1} \, \text{cm}^{-1}$).
$\Omega^{-1}\text{cm}^{-1})$. Cheon et al. (1997) [39] also reported that the conductivity of amorphous MoS$_2$ films deposited at 200°C by CVD method is very near 1.0 $\Omega^{-1}\text{cm}^{-1}$. Levasseur et al. (1995) [46] and Schmidt et al. (1995) [47] have separately shown that molybdenum sulphide thin films with low oxygen content have high conductivity value ($10^{-1} \Omega^{-1}\text{cm}^{-1}$) with semiconducting behavior when compared with films with high oxygen content ($10^{-5} \Omega^{-1}\text{cm}^{-1}$). This is an indication that our film contains little or no oxygen.

Figures 5(a) and 5(b) show the SEM micrographs of

![Figure 5(a)](image1)

![Figure 5(b)](image2)

Figure 5. Scanning electron micrograph of the thin film. ((a). Magnification: 39.80 kx; (b). Magnification: 63.99 kx.)
the films at various magnifications. These clearly show the layered structure associated with molybdenum sulphide thin films. The micrographs were analyzed using IMAGEJ software to obtain the grain size. The average grain size was estimated to be below 2 µm. The films appear to be dense, homogeneous and of compact structure with closely packed grains. Upon closer inspection at high magnification, it is apparent that the films are pin-hole free and continuous with uniformly distributed grains which covered the substrate very well.

Atomic Force Microscopy was done in the non contact mode. The surface roughness of the films over a cross sectional area of 10 µm² is as shown (in 2-D) in Figure 6. Root mean square surface roughness values for the film is less than 50 nm, indicating that the films are relatively smooth. The root mean square was obtained at a scan rate of 0.7 Hz. The relatively low root mean square roughness value coupled with dimension of the grain indicates the effectiveness of this technique in particle size distribution and production of films of high quality that is relatively smooth.

The XRD diffraction pattern of the film is shown in Figure 7. Intense peaks occur at diffraction angles, 2θ = 11.37°, 14.39°, 29.03°, 32.68°, 33.51°. This confirms the crystalline nature of the film. The diffraction pattern indicates MoS₂ structure (Card Number 37-1492). The peak at 2θ = 14.39° corresponds to (002) plane, 29.03° to (004) plane, 32.68° to (100) plane and 33.51° to (101). The peaks corresponding to (002) and (004) indicates parallel orientation of the basal (Van der Waals) plane to the substrate surface while those that correspond to (100) and (101) indicate perpendicular orientation of the basal plane. However the intensities of the peaks corresponding to the (00l) (l = 2, 4) planes are higher than that of the (100) and (101) planes. This indicates the formation of highly textured film with the Van der Waals planes oriented parallel to the surface of the substrate. This property is of particular importance for photovoltaic and tribological applications [11,13]. The peak at 2θ = 11° can be attributed to a local (002) interplanar expansion of the crystal structure normal to MoS₂ planes [49]. The peaks at 2θ = 24.95° and 27.00° can be attributed to the substrate which may be due to the small thickness of the film. The lattice constant c found from the XRD data was
found to be 12.31 Å. This value is approximately the same value (12.298 Å) reported in the literature (File Number 37-1492). The good agreement of the value of \( c \) with the standard is an indication that our film contains little or no impurities. Even if there are impurities, the impurities did not dissolve in the film but may concentrate at the grain boundaries.

4. Conclusion

On the basis of the above experimental results, bis-(morpholinodithioato-s,s’)-Mo was prepared as a single solid source precursor from commercial reagents. This has not been hitherto used as a precursor in any MOCVD technique employed in the preparation of molybdenum sulphide thin film. Thermal decomposition of bis-(morpholinodithioato-s,s’)-Mo yields molybdenum sulphide thin film in which compositional study with RBS gave the stoichiometric ratio of the film to be Mo:S = 0.33:0.67 while the thickness was estimated to be 70 nm. It is believed that the deposition of molybdenum sulphide thin film from single solid precursor using MOCVD technique provides another method of depositing molybdenum sulphide thin film, with the advantage of large area deposition. A simple and cost effective method that is well suitable for large scale production of molybdenum sulphide thin film is established.

Optical absorption measurement indicates a material that is highly absorbing in the visible part of the spectrum with a direct optical energy band gap of 1.77 eV. Electrical characterization of the film using the four point probe method gave the value of sheet resistance and conductivity to be 2.25 × 10⁵ Ω·sq and 0.86 Ω·cm⁻¹ respectively.

The morphology of the film shows the layered structure associated with molybdenum sulphide thin films while the average grain size is less than 2 µm. XRD shows the crystalline nature of the film indicating parallel orientation of the basal (Van der Waals) plane to the substrate with lattice constant \( c \) estimated to be 12.31 Å.

5. Reference


